



Atty Docket No. MXIC 1518-2

CERTIFICATE OF MAILING

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Sue Bromaghin

18 February 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Lenvis LIU et al.

Application No. 10/695,167

Confirmation No. 7158

Filed: 28 October 2003

Title: Finger Metal-Insulator-Metal Capacitor
Device with Local Interconnect

Group Art Unit: 2811

Examiner: *unassigned*

Customer No. 22470

MS Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

TRANSMITTAL OF SUPPLEMENTAL APPLICATION DATA SHEET

Sir:

In connection with the above-referenced U.S. patent application, transmitted herewith is a Supplemental Application Data sheet, correcting the suggested drawing figure for publication and the city of residence for the second inventor. No fee is due.

Authorization is given to charge Deposit Account No. 50-0869 (MXIC 1518-2), any fees associated with this document.

Respectfully submitted,

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Dated: 18 February 2004

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Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Title::	Finger Metal-Insulator-Metal Capacitor Device with Local Interconnect
Attorney Docket Number::	MXIC 1518-2
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	1 <u>9</u>
Total Drawing Sheets::	4
Small Entity?::	No

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Representative Information

Representative Customer Number::	22470	
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	Division of	10/077,450	02/15/2002

Assignee Information

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